HFMP5643 TYPE

FEATURE

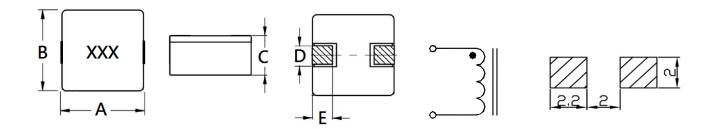
- 1. Shielded construction
- 2. High current and low DCR for flat wire type
- 3. Cross out as Wurth 744316xxx

Applications

1. Notebook, server application, High current power supplier

Shape and Dimension

Schematics and Land Patterns(mm)



 $A = 5.60 \pm 0.30 \, \text{m/m} \; ; \; B = 5.30 \pm 0.30 \, \text{m/m} \; ; \; C = 4.30 \, \text{m/m} \; MAX; \; D = 1.00 \pm 0.30 \, \text{m/m}; \; E = 1.20 \pm 0.50 \, \text{m/m} \; ; \; C = 4.30 \, \text{m/m} \; ; \;$

Specification

| | L | RDC | RDC | Isat | Irms |
|---------------|----------|--------------|----------|------|-------|
| P/N | (µH) | (mΩ) Typical | (mΩ) Max | (A) | (A) |
| HFMP5643-R22M | 0.22±20% | 1.25 | 1.38 | 25 | 20 |
| HFMP5643-R33M | 0.33±20% | 1.75 | 1.93 | 20 | 18.5 |
| HFMP5643-R47M | 0.47±20% | 2.75 | 3.03 | 16 | 15 |
| HFMP5643-R68M | 0.68±20% | 4.00 | 4.40 | 13.5 | 12.75 |
| HFMP5643-1R0M | 1.0±20% | 4.75 | 5.23 | 11.5 | 11.5 |
| HFMP5643-1R5M | 1.5±20% | 8.15 | 8.97 | 9.0 | 9.0 |
| HFMP5643-2R2M | 2.2±20% | 11.30 | 12.43 | 7.5 | 7.5 |
| HFMP5643-3R3M | 3.3±20% | 18.50 | 20.35 | 5.8 | 5.75 |
| HFMP5643-4R7M | 4.7±20% | 24.50 | 26.95 | 4.7 | 4.6 |
| HFMP5643-5R6M | 5.6±20% | 28.50 | 31.35 | 4.6 | 4.5 |

Note1. Measurement frequency of Inductance value : at 100KHz

Note2. Measurement ambient temperature of L, DCR and IDC : at $25^{\circ}\!\mathbb{C}$

Note3. Isat: DC current at which the inductance drops 30%(typ) from its value without current

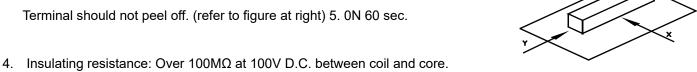
Note4. Irms: Average current for 50°C temperature rise from 25°C ambient(typical)

Note5. Inductance tolerance: M: ±20%

Note6. Packaging: Taping; Quantity: 1000 pieces/reel

GENERAL CHARACTERISTICS

- 1. Operating temperature range: -40 TO + 150°C (Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Ywithstanding at below conditions.



- Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C (-25~+80°C).
- Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2°C and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260℃, 10 seconds(See attached recommend reflow)
- 11. Storage environment: Storage condition: Temperature Range: 10° C ~ 35° C (Generally: 21° C ~ 31° C) , Humidity Range: 50% ~ 80% RH (Generally: 65% ~ 75%); Transportation condition: Temperature Range: -35°C ~ 85°C , Humidity Range: 50% ~ 95% RH
- 12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
- 13. Reflow profile recommend:

Lead-free heat endurance test

Lead-free the recommended reflow condition

